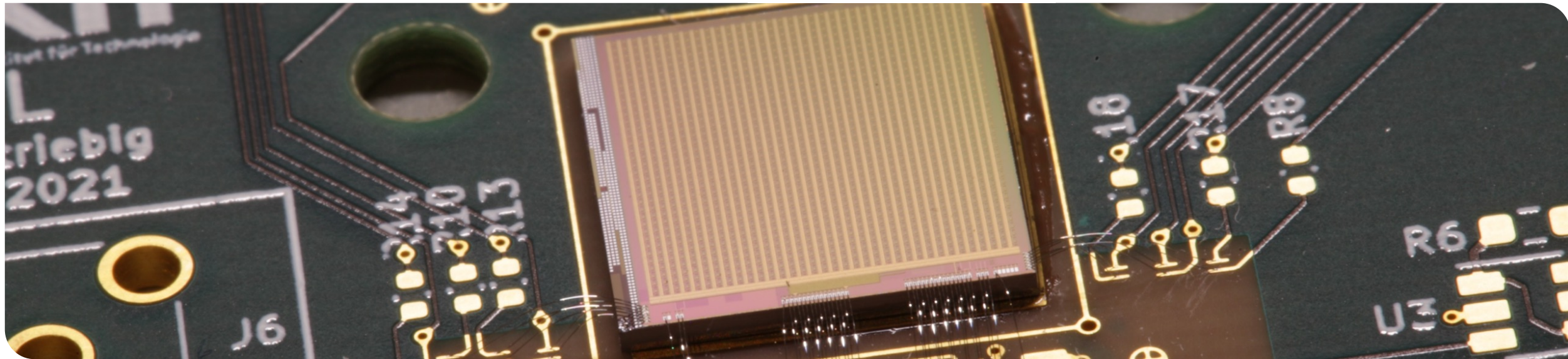


AstroPix: A novel HV-CMOS pixel sensor for space-based experiments

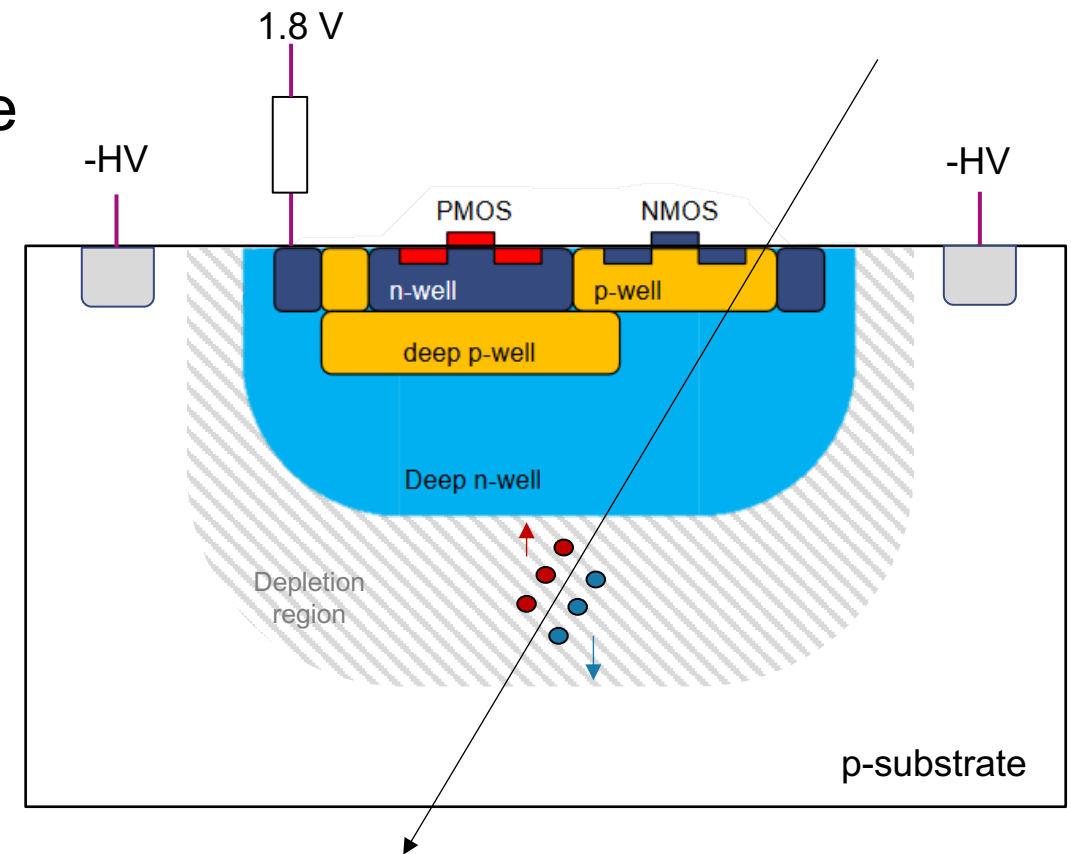
Richard Leys, Ivan Perić, **Nicolas Striebig***

**striebig@kit.edu*



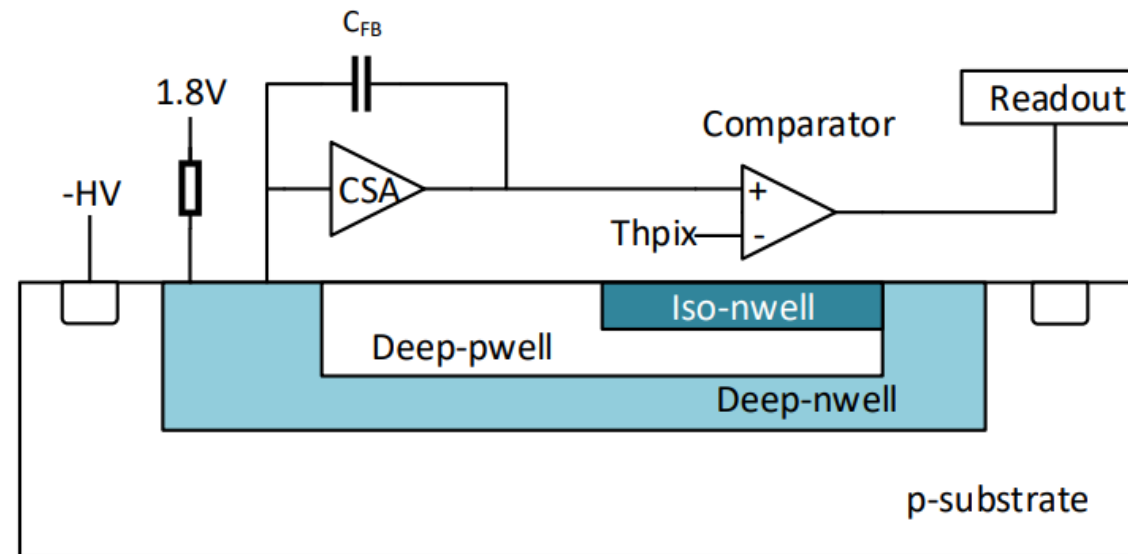
Introduction – HV-CMOS

- Charged particles or photons generate electron-hole pairs in depletion region of the sensing diode formed by deep n-well and p-substrate
- Separated by strong electric field
- Electrons drift to charge-collecting deep n-well
- Deep n-well contains shallow wells for electronics
- **High-Voltage CMOS Active Pixel Sensor (HVMAPS)**



Introduction – HV-CMOS sensor

- Pixel contains amplifier, pulse shaping and comparator
- Pixel electronics isolated by deep n-well
- CMOS comparator n-well isolated by deep p-well → quadruple well



Introduction – CSA

- Voltage over feedback capacitance (Inverting amplifier $V_{out} = -AV_{in}$)

$$V_{fb} = V_{in} - V_{out} = V_{in} - (-V_{in} \cdot A) = V_{in}(1 + A)$$

- Charge on Q_{fb}

$$Q_{fb} = C_{fb}V_{fb} = C_{fb}V_{in}(1 + A) = C_{eff}V_{in}$$

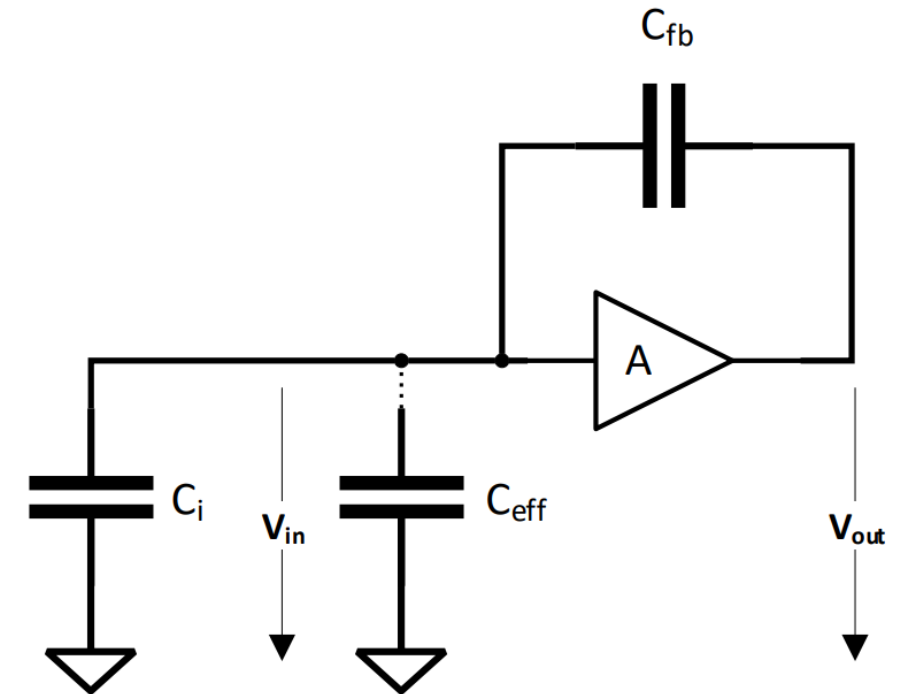
- Looking into amplifier the detector sees an effective capacitance $C_{fb}(A+1)$

- Input charge is distributed between capacitances

$$V_{in} = \frac{Q_{in}}{C_i + C_{eff}} = \frac{Q_{in}}{C_i + (1 + A)C_{fb}}$$

- Output voltage (If $A \gg 1$ and $A C_{fb} \gg C_i$)

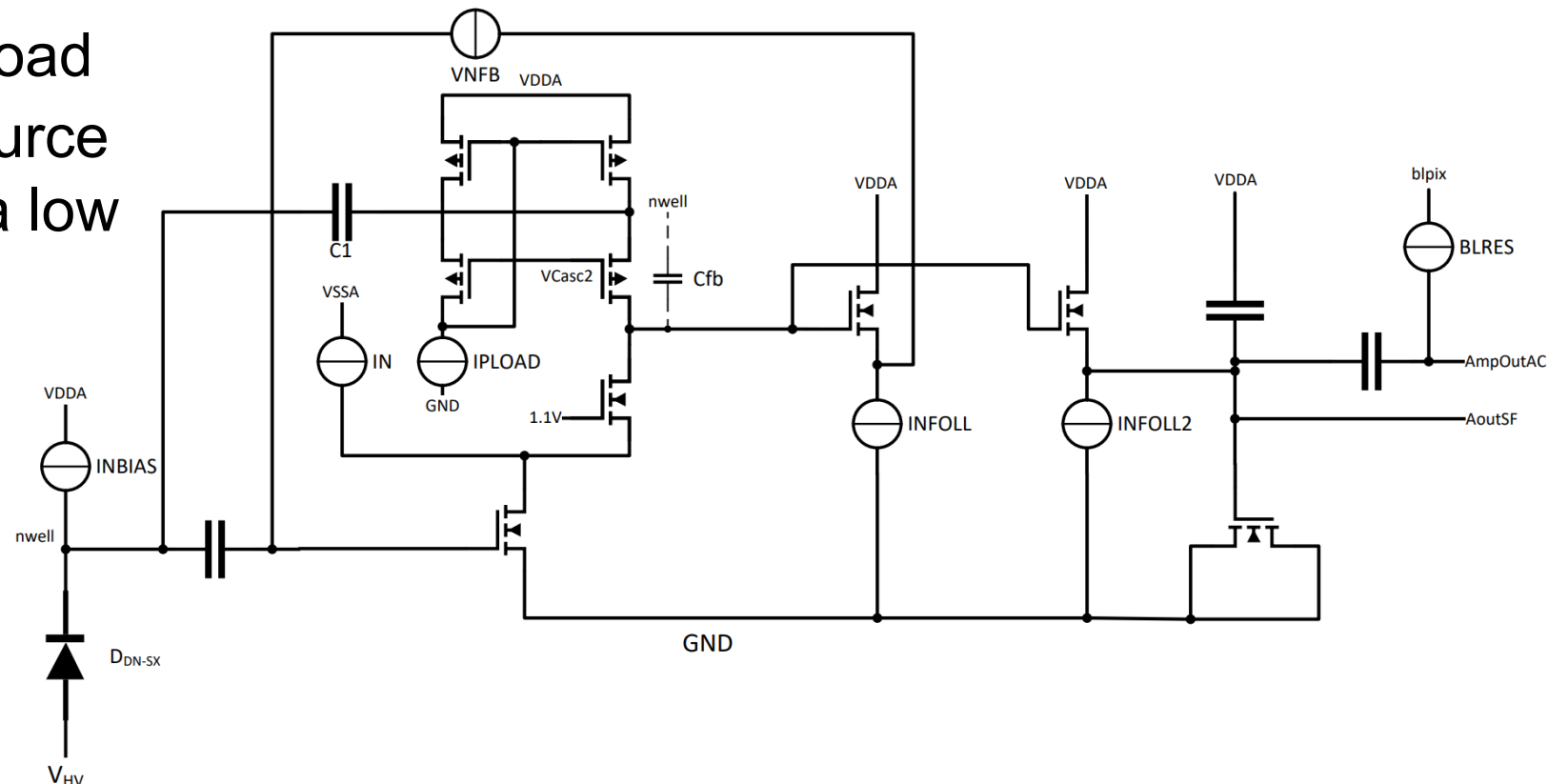
$$V_{out} = -\frac{Q_{in}A}{C_i + (1 + A)C_{fb}} = -\frac{Q_{in}}{C_{fb}} \frac{1}{\frac{C_i}{AC_{fb}} + \frac{1}{A} + 1}$$



$$V_{out} = -\frac{Q_{in}}{C_{fb}}$$

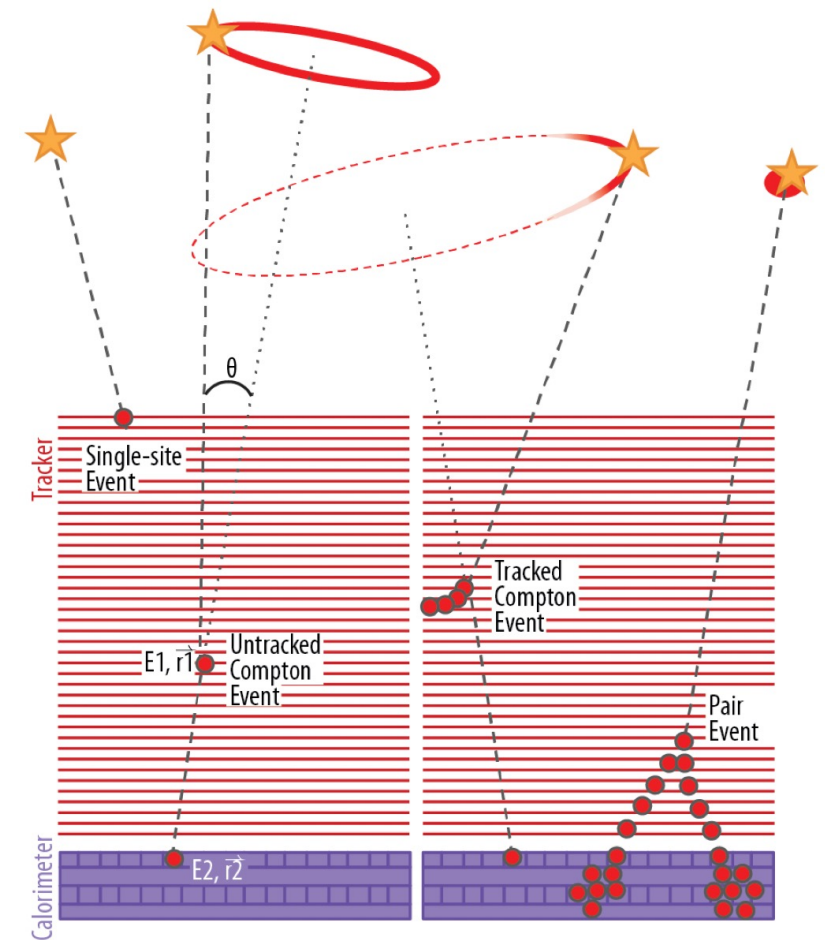
Introduction – AstroPix CSA

- Simplified amplifier schematic
- NMOS type cascoded amplifier with cascode load
- Output connected to source follower SF2 acting as a low pass filter
- AC coupled to CMOS comparator input



Introduction - Compton camera

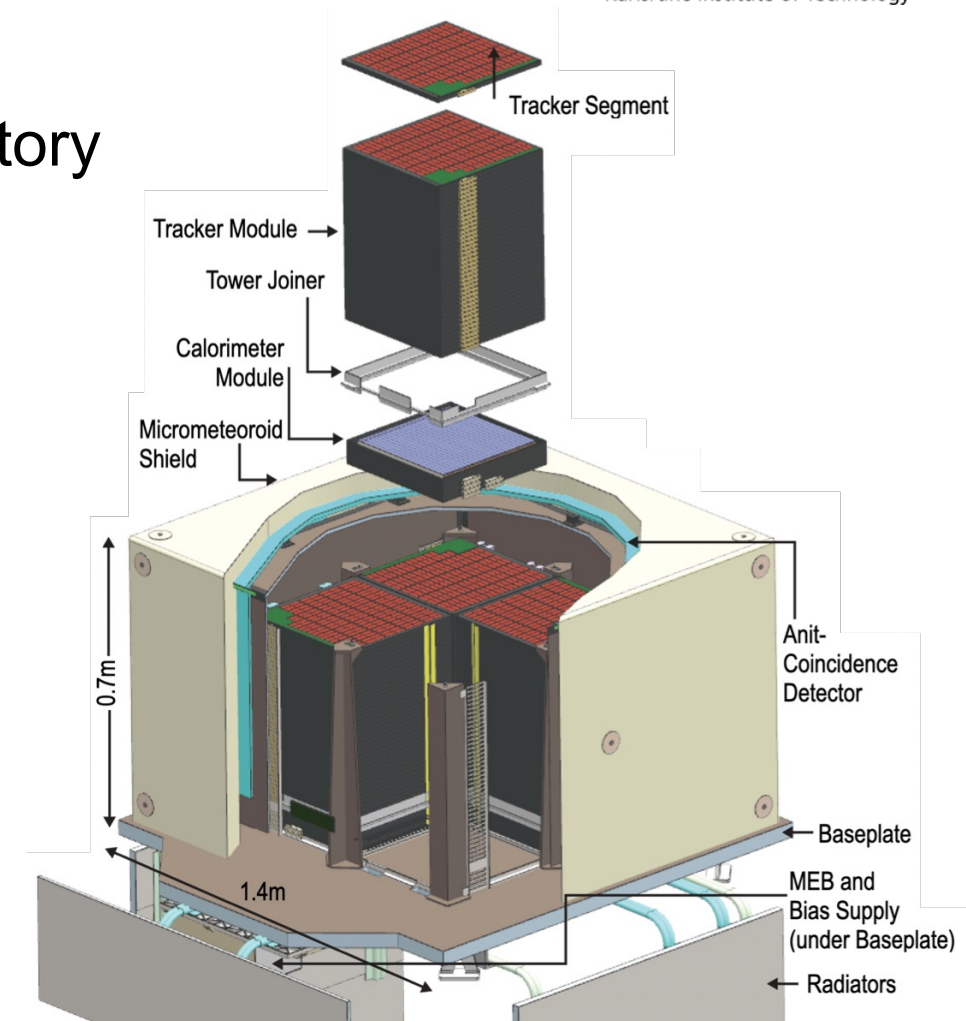
- Primary photon scattering an electron
- Energy of photon decreases and angle of movement changes
→ transferred to recoil electron
- Tracker records position and energy deposit of recoil electron through it
- Calorimeter measures position and energy of photon
- Energies and locations of interaction used to estimate direction of primary photon



Schematic of Compton and pair events inside tracker. [1]

Introduction – AMEGO-x

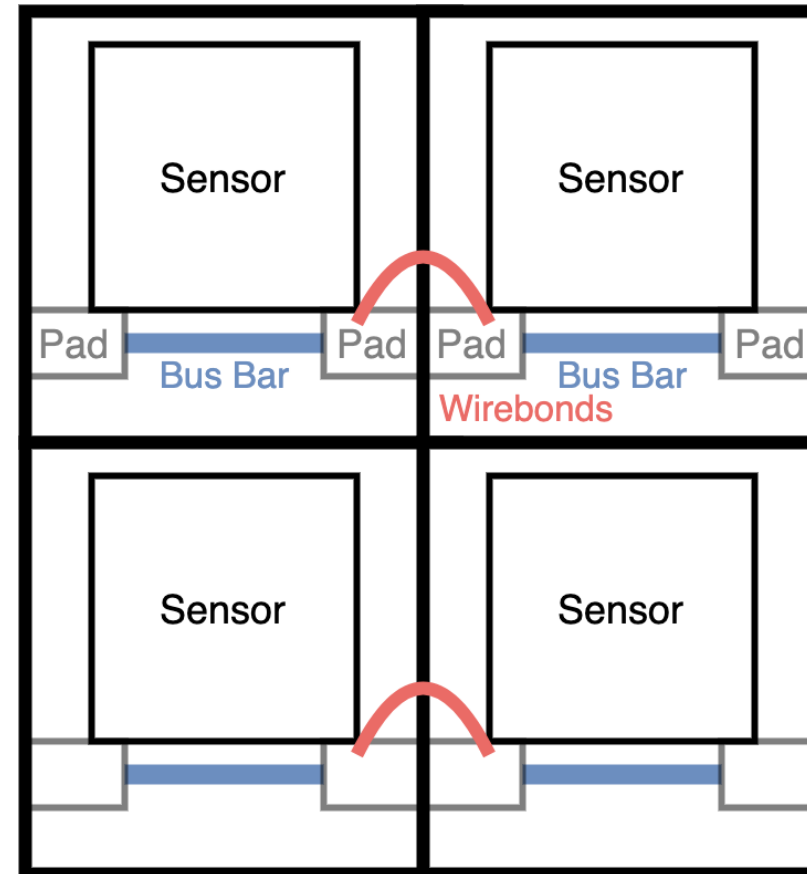
- NASA MIDEX concept for space based observatory
- Wide-field survey telescope designed to discover and characterize gamma-ray emission
- 3 year mission
- Set to take off in 2028
- HV-CMOS sensor for Compton camera



Exploded view of AMEGO-x instrument. [1]

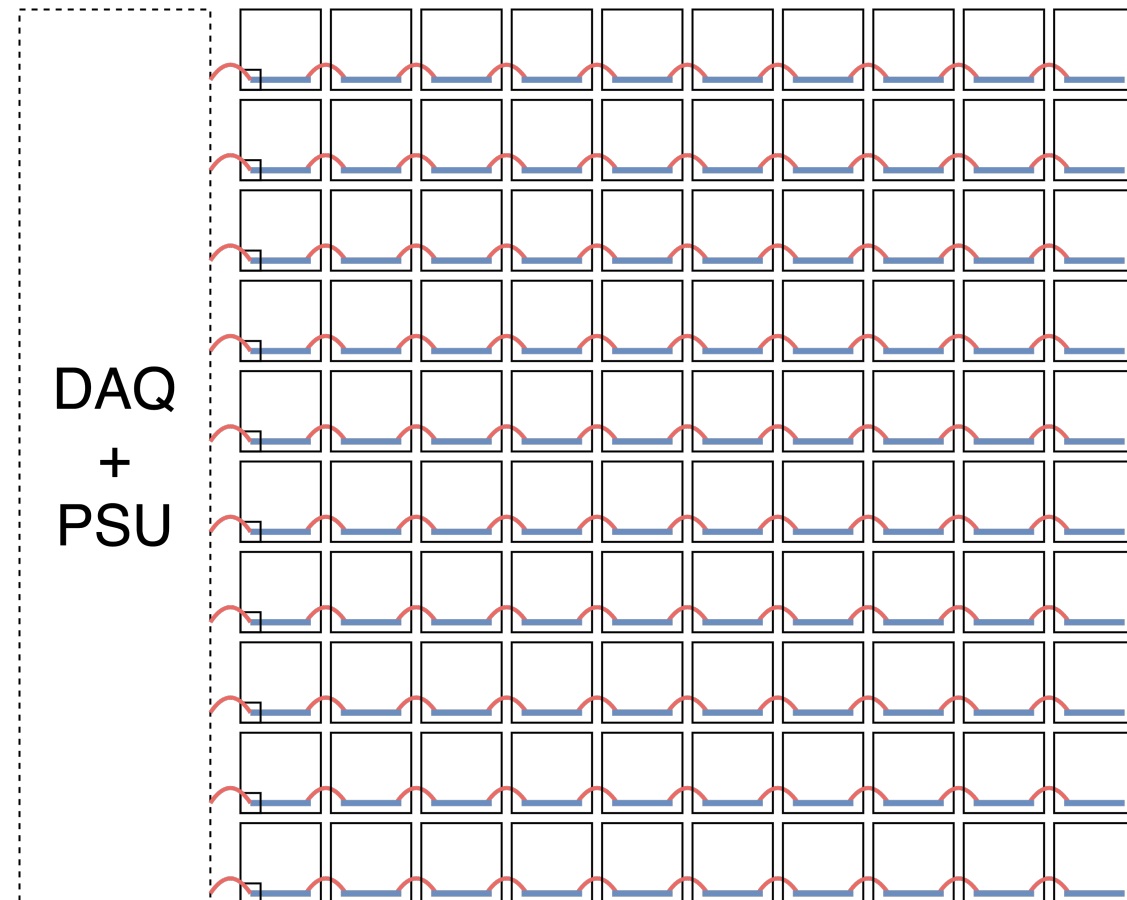
Introduction – Tracker modules

- Quadchip: 2 x 2 chips
- Layer: 10 x 10 Quadchips
- Tower: 40 Layers
- Tracker: 4 Towers



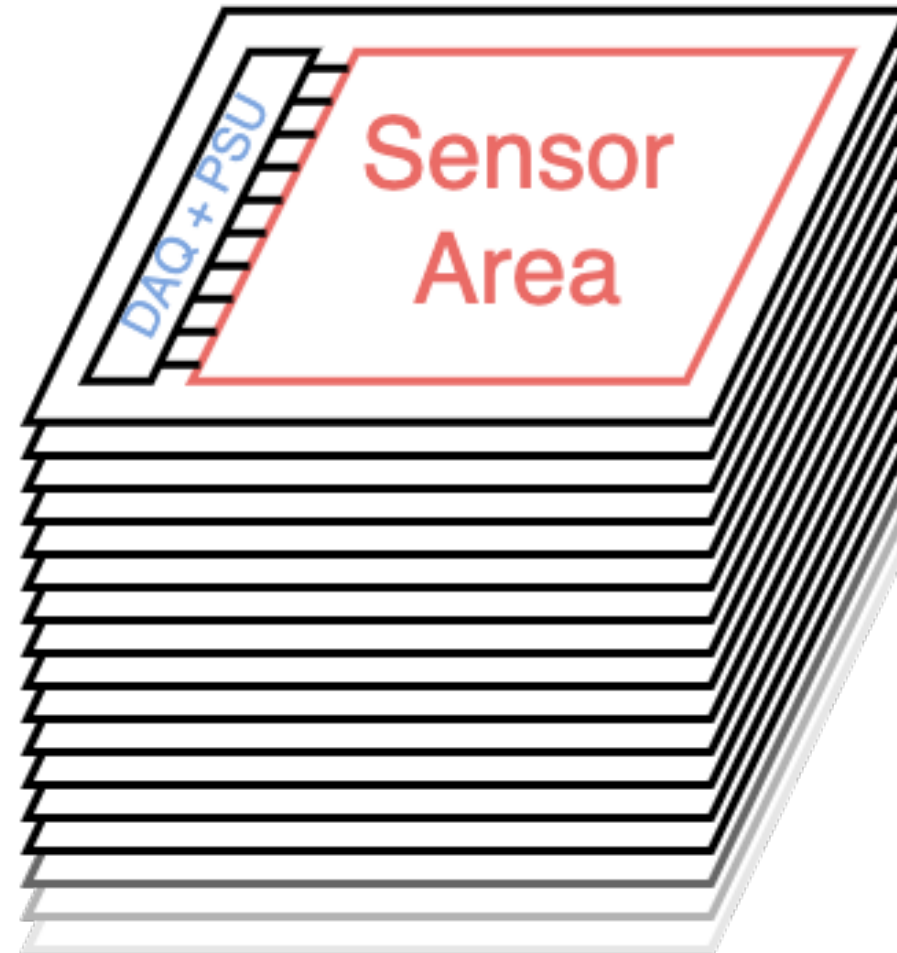
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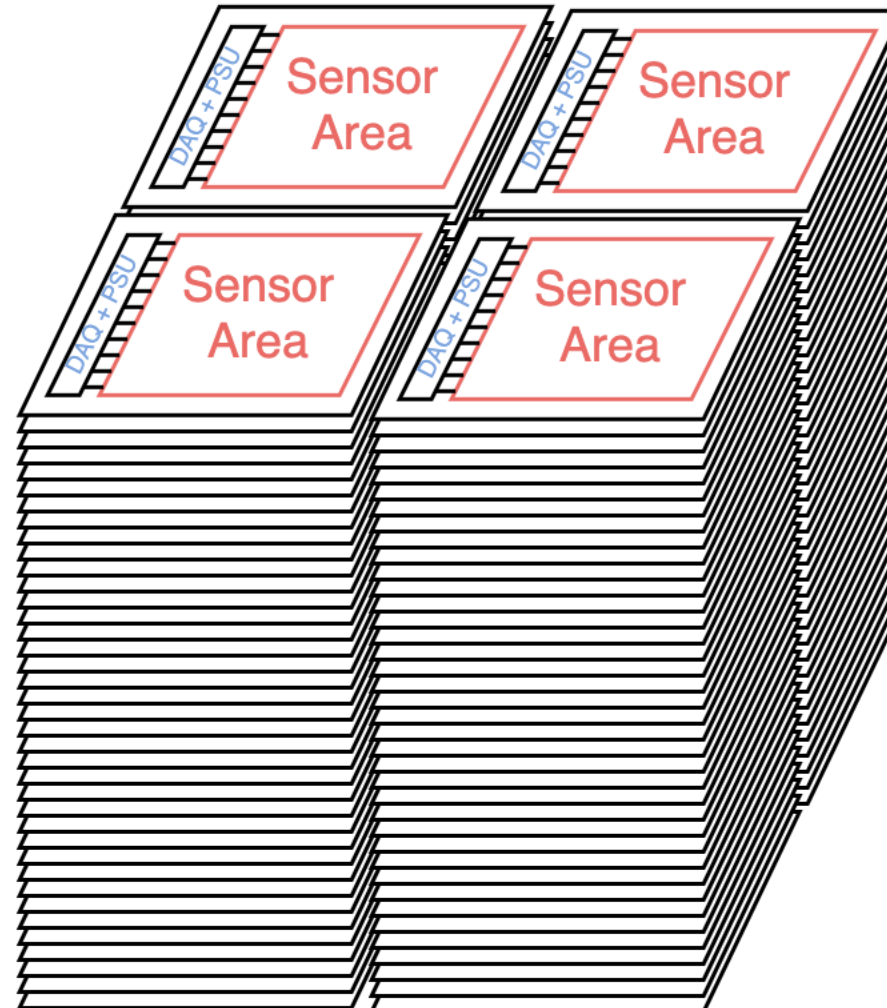
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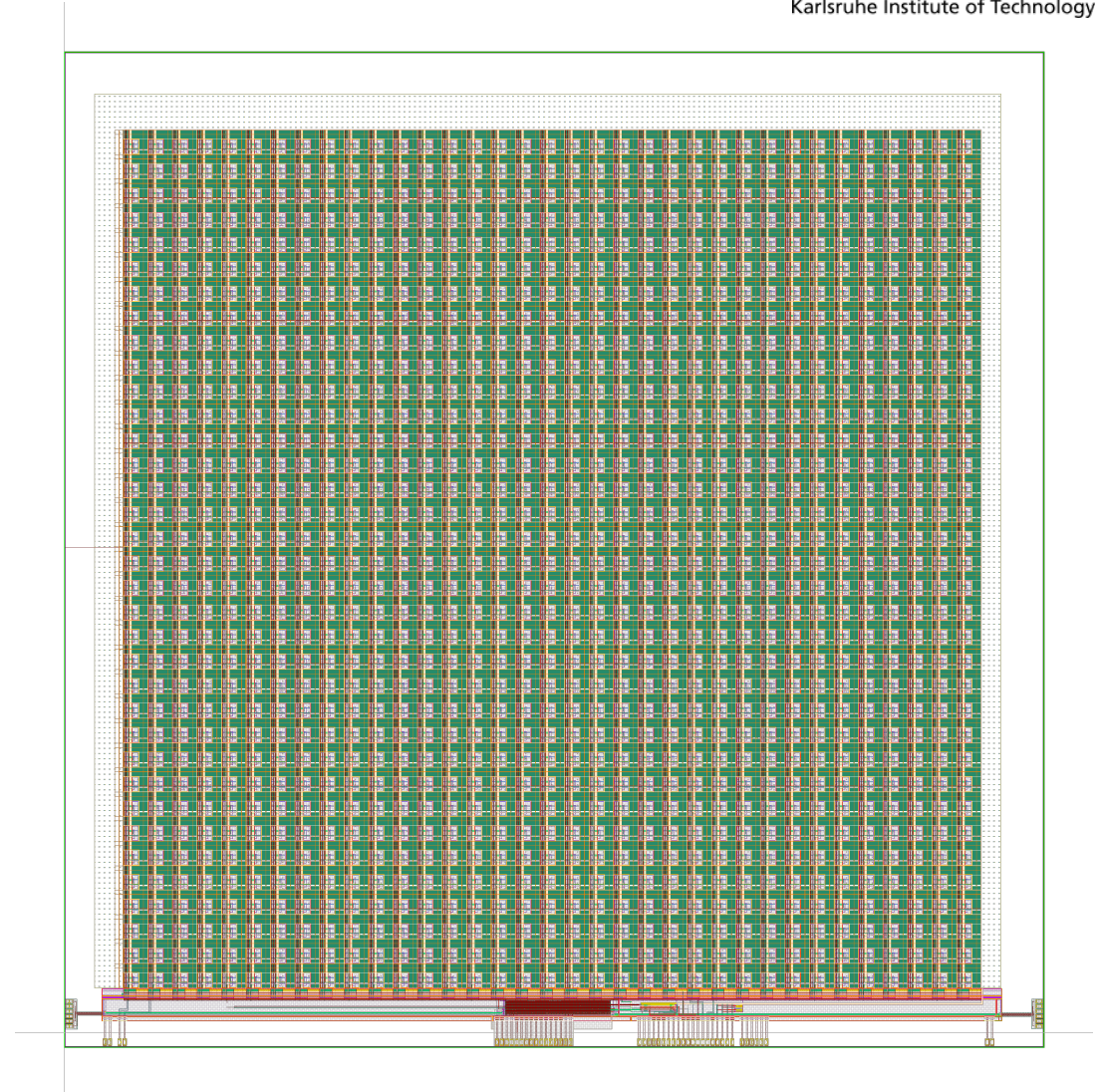


64000 sensors
25.6 m² area

New AstroPix v3 Specs

- Chip size: 2 cm x 2 cm
- Matrix: 35 x 35 pixel
- Pixel pitch: 500 μm
- DigitalTop from v2
 - QSPI Interface
 - 5 byte frame (10 byte per hit)
- Clocks (provided externally):
 - 200 MHz for ToT
 - 2 MHz for Timestamp
- Integrated 10bit voltage DACs
- Integrated temperature sensors
- Integrated injection switch

Submitted in July 2022



Amego-x Requirements

- **Power target:**

Increase 250 μm pixel pitch (AstroPix v2) to 500 μm to reach 1.5 mW/cm^2 (ATLASpix3: 150 mW/cm^2)

- **Dynamic range:**

20 – 700 keV with 5 keV resolution

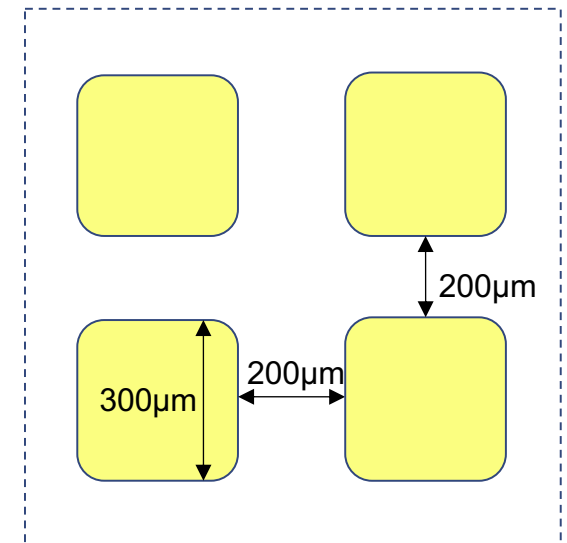
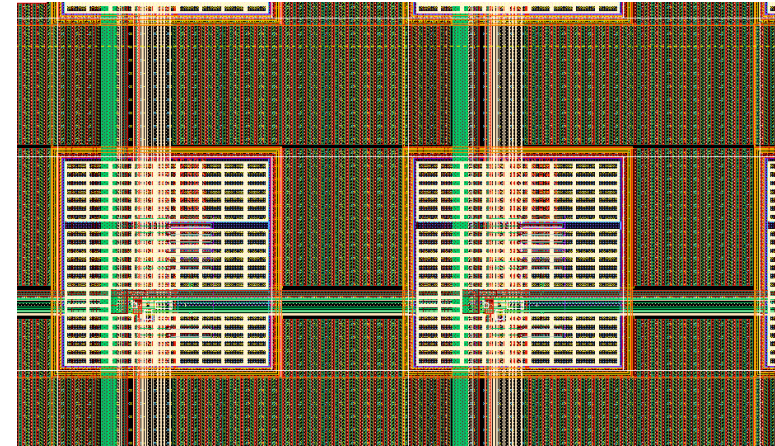
- **SEU tolerance**

- **Problems:**

- Large pixel size results in high noise
- To absorb high energies \rightarrow chip has to be fully depleted

How to increase pixel pitch without drastically increasing noise?

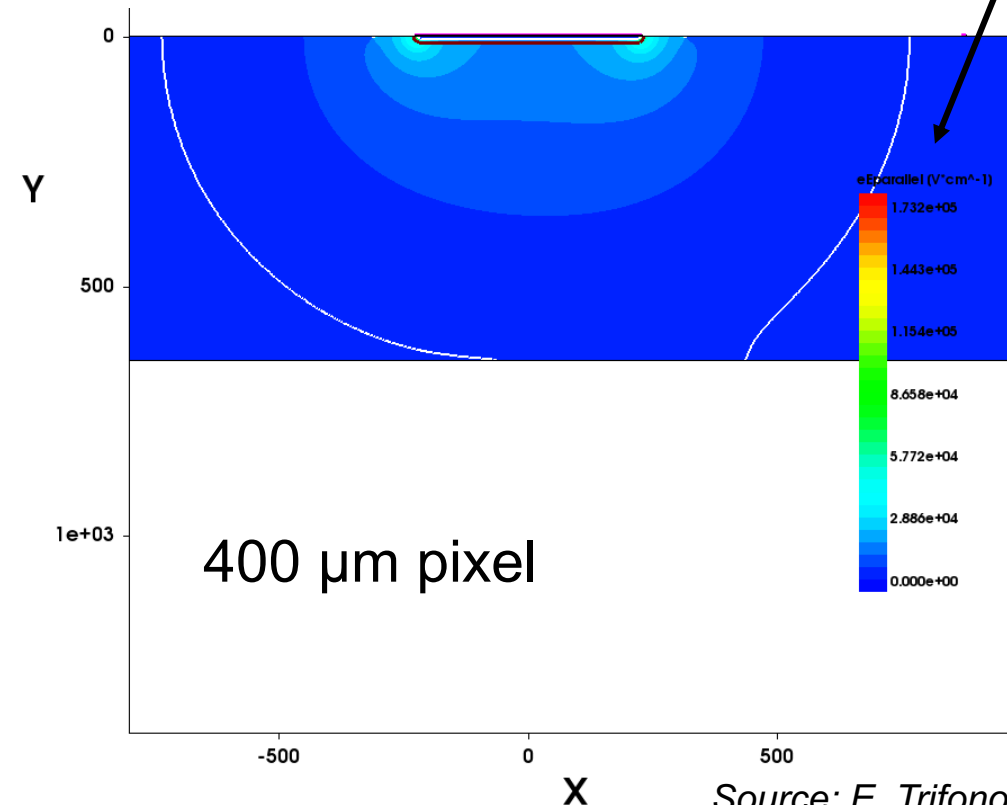
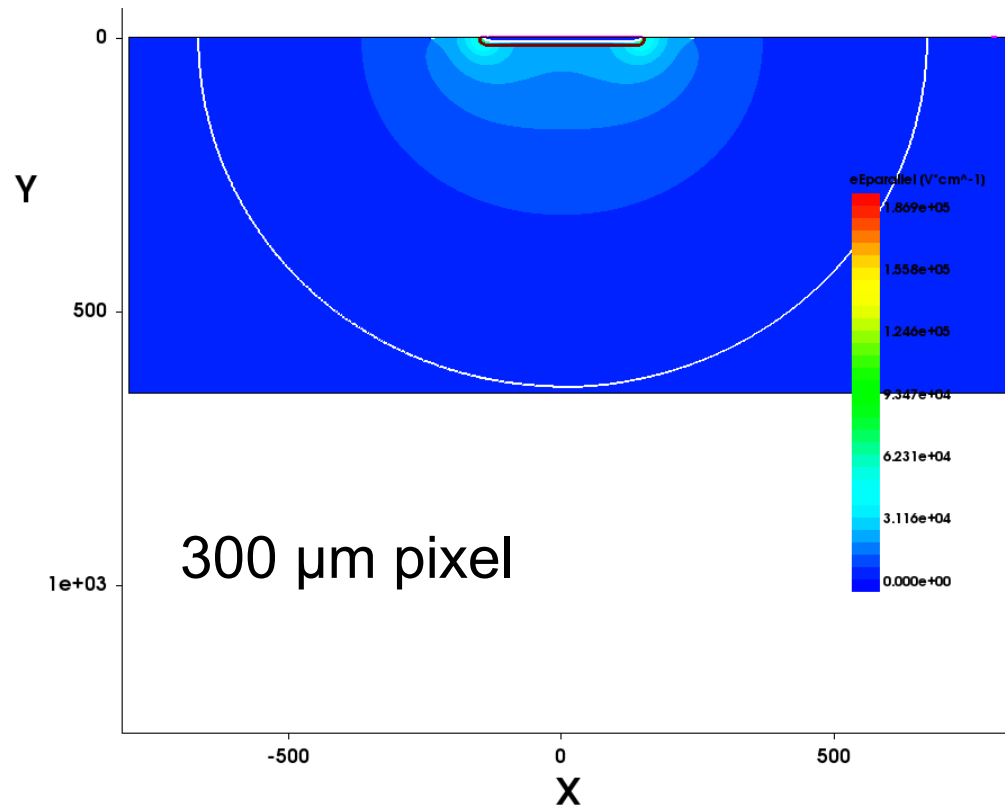
- Idea:
 - Increase spacing from 25 to 200 μm
 - Reduce pixel size to 300 μm
- Features:
 - Reduced pixel capacitance
 - Reduced wiring-to-nwell capacitance
 - Small change to current pixel design
 - Meets local density requirements 😊
- Simulation result:
 - ENC of 225 e^- with estimated 1 pF pixel capacitance
 - RMS Noise equals an 800 eV input signal



TCAD Simulations

- 500 μm pitch, 300 μm pixel size, HiRes 10 kOhm-cm substrate
- **New Guardring design** with breakdown improved to **$\sim 400\text{ V}$**

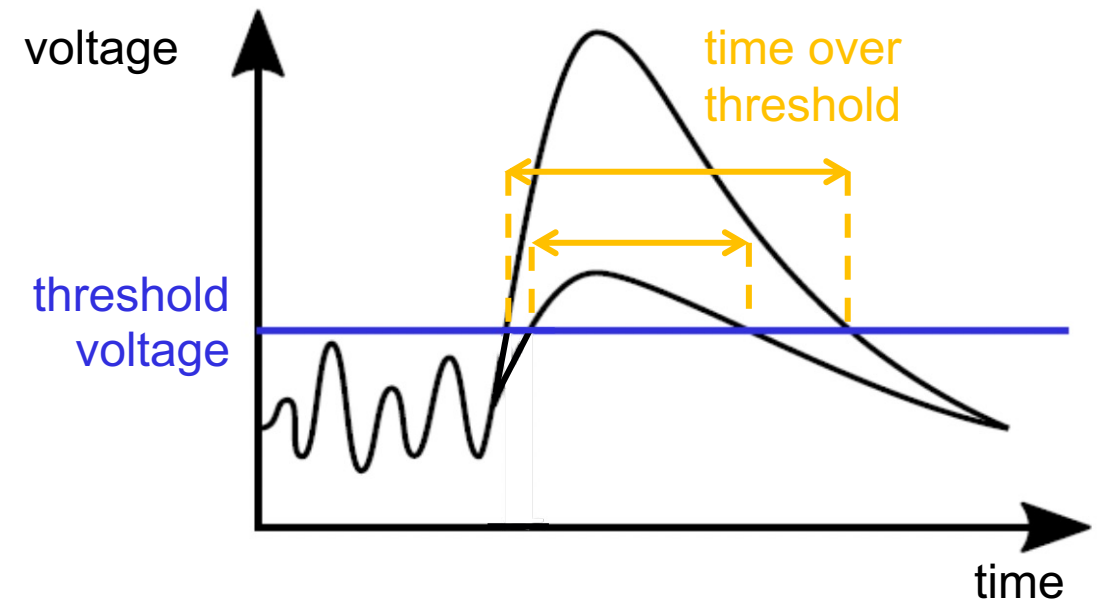
Scale from 0 to $1.869 \times 10^5\text{ V cm}^{-1}$



Source: E. Trifonova (KIT IPE)

How to measure energy deposit of recoil electron?

- Amplifier output signal proportional to collected charge
- Output amplitude saturates at certain level → peak amplitude not usable to determine energy over large dynamic range
- ToT still non-linearly scales with charge
- Measured with 12bit @ 200 MHz counter
- Expected ToT between 500 ns and 20 μ s



Schematic description of time over threshold. Adapted from [2].

Outlook on AstroPix v4

- ToT measurement will be performed with an asynchronous TDC
 - On-chip power consumption for ToT measurement reduced by 3 orders of magnitude
 - No fast clock distribution needed anymore → huge power savings on system level
- Digital circuitry especially FSMs will be triplicated to make readout logic more robust against SEU
 - Small test chip has already been submitted

Summary

- AstroPix is a very low power and high dynamic range sensor
- Designed for daisy-chaining → simplifies tracker module design
- Ability to deplete thick sensors would enable new applications of HV-CMOS sensors
 - Detection of high energy photons
 - Direct energy measurement of charged particles

References

- [1] Regina Caputo et al. *The All-sky Medium Energy Gamma-ray Observatory eXplorer (AMEGO-X) Mission Concept*. (Submitted in 2022 to Journal of Astronomical Telescopes, Instruments, and Systems)
- [2] H. Augustin et al. *The MuPix sensor for the Mu3e experiment*. Nucl. Instrum. Meth. A, 979:164441, 2020.